VEMD3160FX01

Vishay Semiconductors



Silicon PIN Photodiode

FEATURES

- · Package type: surface-mount
- Package form: PLCC-2
- Dimensions (L x W x H in mm): 3.5 x 2.8 x 1.75
- Daylight blocking filter
- AEC-Q101 qualified
- Excellent I_{ra} linearity
- Fast response times
- Angle of half sensitivity: $\varphi = \pm 60^{\circ}$
- Floor life: 168 h, MSL 3, according to J-STD-020
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- High speed photo detector
- Small signal detection
- Proximity sensors

PRODUCT SUMMARY				
COMPONENT	I _{ra} (μΑ)	φ (°)	λ _{0.5} (nm)	
VEMD3160FX01	1.6	± 60	860 to 1030	

Note

DESCRIPTION

Test conditions see table "Basic Characteristics"

VEMD3160FX01 is a high speed and high sensitive PIN

photodiode with a highly linear photoresponse.

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
VEMD3160FX01-GS08	Tape and reel	MOQ: 7500 pcs, 1500 pcs/reel	PLCC-2	

Note

• MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V _R	5	V
Junction temperature		TJ	110	°C
Ambient temperature range		T _{amb}	-40 to +110	°C
Storage temperature range		T _{stg}	-40 to +110	°C
Soldering temperature	According to reflow solder profile	T _{sd}	260	°C

AUTOMOTIVE GRADE



COMPLIANT HALOGEN

GREEN

(5-2008)



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BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I _F = 50 mA	V _F	-	0.9	-	V
Breakdown voltage	I _R = 100 μA, E = 0	V _(BR)	20	-	-	V
Reverse dark current	$V_{R} = 5 V, E = 0$	I _{ro}	-	1	3	nA
Diode capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0$	CD	-	1.9	-	pF
	$V_{R} = 3 V, f = 1 MHz, E = 0$	CD	-	1	-	pF
Temperature coefficient of Ira	$E_e = 1 \text{ mW/cm}^2, \lambda = 940 \text{ nm}$	TK _{lra}	-	0.26	-	%/K
Reverse light current	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 940 \text{ nm}$, $V_R = 5 \text{ V}$	I _{ra}	1.14	1.6	2.25	μA
	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 890 \text{ nm}$, $V_R = 5 \text{ V}$	I _{ra}	-	1.5	-	μA
Angle of half sensitivity		φ	-	± 60	-	0
Wavelength of peak sensitivity		λρ	-	920	-	nm
Range of spectral bandwidth		λ _{0.5}	-	860 to 1030	-	nm
Rise time	V_R = 10 V, R_L = 50 Ω , λ = 950 nm	t _r	-	180	-	ns
Fall time	V_{R} = 10 V, R_{L} = 50 Ω , λ = 950 nm	t _f	-	180	-	ns

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

Basic characteristics graphs to be extended to 110 °C ambient temperatures where applicable.

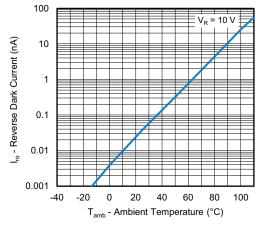


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

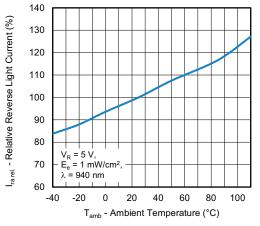


Fig. 2 - Relative Reverse Light Current vs. Ambient Temperature

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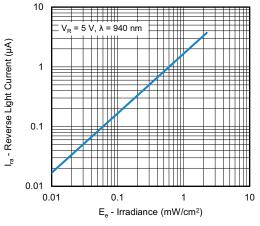


Fig. 3 - Reverse Light Current vs. Irradiance

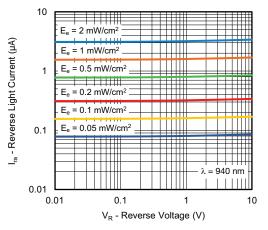


Fig. 4 - Reverse Light Current vs. Reverse Voltage

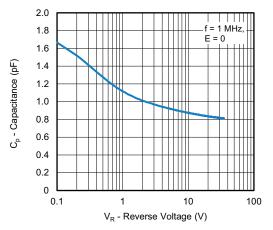


Fig. 5 - Diode Capacitance vs. Reverse Voltage

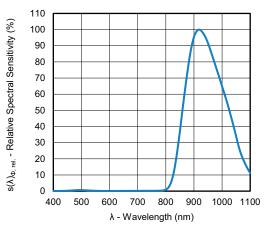


Fig. 6 - Relative Spectral Sensitivity vs. Wavelength

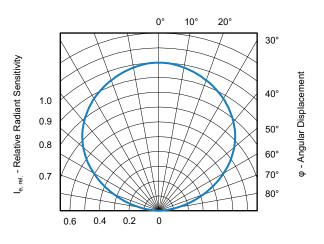


Fig. 7 - Relative Radiant Sensitivity vs. Angular Displacement

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VEMD3160FX01



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Max. 260 °C

Max. 30 s

Max. 100 s

200

Max. ramp down 6 °C/s

250

300

245 °C

REFLOW SOLDER PROFILE

300

250

200

150

100

50

0 0

Temperature (°C)

19841

255

-240 °C

217 °C

Max. 120 s

100

150

Time (s)

Fig. 8 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

Max. ramp up 3 °C/s

50

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

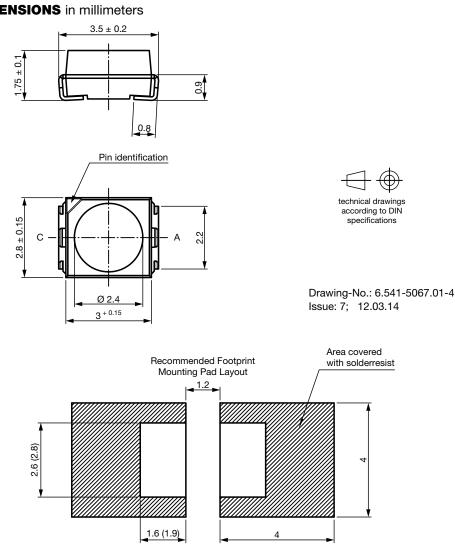
Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 3, according to J-STD-033D.

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-033D or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

PACKAGE DIMENSIONS in millimeters



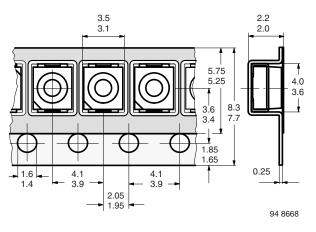
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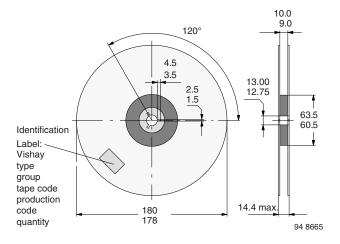


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BLISTER TAPE DIMENSIONS in millimeters



REEL DIMENSIONS in millimeters





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